

CS03-054



*WAF*

To: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

February 08, 2005

Fr: Stephen B. Ackerman, Reg. No. 37,761  
28 Davis Ave.  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/763,305

01/23/2004

J. P. Liu et al

"METHOD OF FORMING A RELAXED  
SEMICONDUCTOR BUFFER LAYER ON A  
SUBSTRATE WITH A LARGE LATTICE  
MISMATCH"

GRP. Art. Unit 2829

A. K. Sarkar

### AMENDMENT

Dear Sir;

In response to the FINAL office action dated January 14, 2005, please amend the identified application for patent as follows:

The commissioner is hereby authorized to charge payment of any additional fees involved with added Claims and the like to Deposit Account No. 19-0033

### CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on *March 14*, 2005.

Stephen B. Ackerman, Reg. No. 37,761

Signature

A handwritten signature in dark ink, appearing to be "SBA", written over a horizontal line.

Date

*3/14/05*

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Remarks begin on page 3.